



## Manufacturing Metrology

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### Message from the Guest Editors

This Special Issue welcomes papers revealing novel measurement methodologies and instrumentations for manufacturing metrology from conventional industry to the frontier of advanced hi-tech industry. We are proud to work with a team of skillful editorial assistants and highly efficient and experienced reviewers. Under our services, your research outcomes can be realized in the production of high-quality papers within a short time. Please submit your manuscripts related to, but not limited to, the following areas:

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2. New technology or instruments for on-machine measurements.
3. In-process dimensional control or error compensation.
4. Machine tool metrology.
5. Robot metrology.
6. Strategic planning of manufacturing metrology.
7. Traceability, uncertainty analysis of measurement systems.

Deadline for manuscript  
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**closed (30 April 2021)**

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## Message from the Editor-in-Chief

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